N-Ch MOSFET

General Description

The WSD60N10GDN56 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD60N10GDN56 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

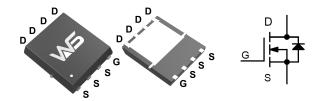
Product Summery

BV _{DSS}	R _{DSON}	I _D
100V	8.5mΩ	60A

Applications

- Power Management in TV Converter.
- DC-DC Converter
- LED TV Back Light

DFN5X6 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	100	V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current	60	Α	
I _{DP}	Pulsed Drain Current	210	Α	
EAS	Avalanche Energy, Single pulse	100	mJ	
P _D @T _C =25℃	Total Power Dissipation	125	W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

Thermal Data

Symbol	Parameter	Тур. Мах.		Unit	
R _{0JA}	Thermal Resistance Junction-Ambient ¹		60	°C/W	
Rejc	Thermal Resistance Junction-Case ¹		1.0	°C/W	



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Electrical Characteristics (T_J=25 C, unless otherwise noted)

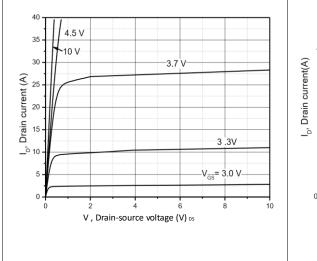
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	100			V
Б	Static Drain-Source On-Resistance	VGS=10V,ID=10A.		8.5	10.0	mΩ
R _{DS(ON)}		VGS=4.5V,ID=10A.		9.5	12.0	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0		2.5	V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =80V , V_{GS} =0V , T_{J} =25 $^{\circ}$ C			1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, V_{DS} = $0V$			±100	nA
Q_g	Total Gate Charge (10V)	V _{DS} =50V , V _{GS} =10V , I _D =25A		49.9		nC
Q _{gs}	Gate-Source Charge			6.5		
Q_{gd}	Gate-Drain Charge			12.4		
T _{d(on)}	Turn-On Delay Time	V_{DD} =50V , V_{GS} =10V , R_{G} =2.2 Ω , I_{D} =25A		20.6		ns
Tr	Rise Time			5		
$T_{d(off)}$	Turn-Off Delay Time			51.8		
T _f	Fall Time			9		
C _{iss}	Input Capacitance	V _{DS} =50V , V _{GS} =0V , f=1MHz		2604		pF
C _{oss}	Output Capacitance			362		
C _{rss}	Reverse Transfer Capacitance			6.5		
I _S	Continuous Source Current	V _G =V _D =0V , Force Current			60	Α
I _{SP}	Pulsed Source Current				210	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =12A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time	IF=12A,dI/dt=100A/μs,T _J =25℃		60.4		nS
Q _{rr}	Reverse Recovery Charge			106.1		nC

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta IA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a =25 °C.
- 5) $V_{DD}=50 \text{ V}$, $R_G=25 \Omega$, L=0.3 mH, starting $T_j=25 ^{\circ}\text{C}$.



Typical Operating Characteristics



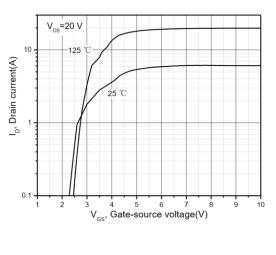
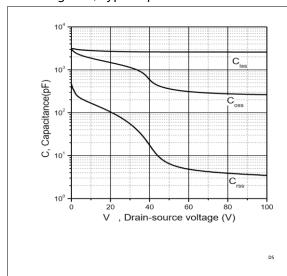


Figure 1, Typ. output characteristics

Figure 2, Typ. transfer characteristics



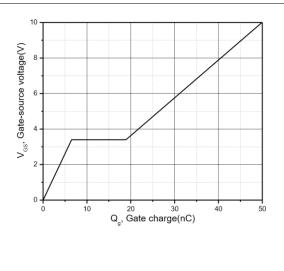
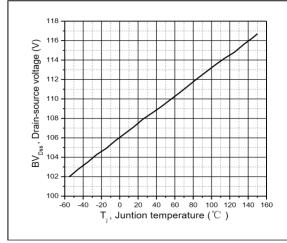


Figure 3, Typ. capacitances

Figure 4, Typ. gate charge



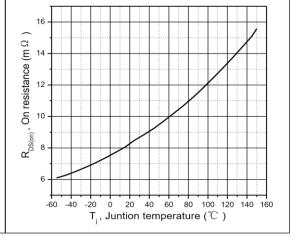
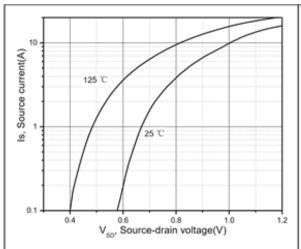


Figure 5, Drain-source breakdown voltage

Figure 6, Drain-source on-state resistance



Typical Operating Characteristics (Cont.)



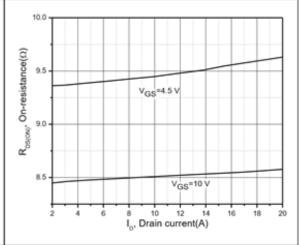
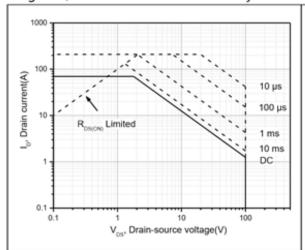


Figure 7, Forward characteristic of body diode

Figure 8, Drain-source on-state resistance





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